

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the Docket Number from SUN08-0855 to SUN08-0255 previously recorded on Reel 021823 Frame 0636. Assignor(s) hereby confirms the Docket Number change.

CONVEYING PARTY DATA

Name	Execution Date
Robert J. Drost	06/27/2008
Alex Chow	06/28/2008
Suwen Yang	06/27/2008
Mark R. Greenstreet	10/15/2008

RECEIVING PARTY DATA

Name:	SUN MICROSYSTEMS, INC.
Street Address:	4150 Network Circle
City:	Santa Clara
State/Country:	CALIFORNIA
Postal Code:	95054

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12252808

CORRESPONDENCE DATA

Fax Number: (530)759-1665
Correspondence will be sent via US Mail when the fax attempt is unsuccessful.
 Phone: 530-759-1663
 Email: edward@parklegal.com
 Correspondent Name: Edward J. Grundler
 Address Line 1: Park, Vaughan & Fleming, LLP
 Address Line 2: 2820 Fifth Street
 Address Line 4: Davis, CALIFORNIA 95618

ATTORNEY DOCKET NUMBER:	SUN08-0255
NAME OF SUBMITTER:	Edward J. Grundler, Reg. No. 47,615

PATENT

OP \$40.00 12252808

Total Attachments: 8

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PATENT ASSIGNMENT

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11/12/2008
500702446

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Robert J. Drost	06/27/2008
Alex Chow	06/28/2008
Suwen Yang	06/27/2008
Mark R. Greenstreet	10/15/2008

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OP \$40.00 12252808

ATTORNEY DOCKET NUMBER:	SUN08-0855
NAME OF SUBMITTER:	Edward J. Grundler, Reg. No. 47,615

Total Attachments: 4

TO: EDWARD J. GRUNDLER COMPANY: PARK, VAUGHAN & FLEMING, LLP

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CORPORATE ASSIGNMENT

WHEREAS, the undersigned,

Robert J. Drost
Alex Chow
Suwen Yang
Mark R. Greenstreet

2211 Via Maderos, Los Altos, CA 94024
1735 Woodland Avenue, Apt. 16, East Palo Alto, CA 94303
6335 Thunderbird Crescent, Apt. 5407, Vancouver, BC V6T 2G9, CANADA
5292 Dunbar Street, Vancouver, BC V691V9, CANADA

hereinafter termed "Inventor(s)", have invented certain new and useful improvements in

INTERCONNECT FOR SURFING CIRCUITS

and have executed a declaration or oath for an application for a United States patent disclosing and identifying the invention:

___ On the ___ day of _____, 20___;

Or

X Said application having Application Number 12/252,808 and filed on 16 October 2008; and

WHEREAS, Sun Microsystems, Inc. a corporation of the State of Delaware, having a place of business at 4150 Network Circle, Santa Clara, CA 95054, (hereinafter termed "Assignee"), is desirous of acquiring the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered jointly or severally by said Inventor(s) (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventor(s) to have been received in full from said Assignee:

1. Said Inventor(s) do hereby sell, assign, transfer and convey unto said Assignee the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply for foreign patents on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a divisional, substitution, continuation, or continuation-in-part of any of said applications; and (d) in and to each and every reissue or extensions of any of said patents.

2. Said Inventor(s) hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventor(s) shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation reissues and


Attorney Docket No. SUN08-0255

ree examinations, opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventor(s) in providing such cooperation shall be paid for by said Assignee.

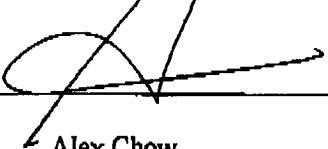
3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor(s), their respective heirs, legal representatives and assigns.

4. Said Inventor(s) hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, said Inventor(s) have executed and delivered this instrument to said Assignee as of the dates written below.



Robert J. Drost Date 6/27/2008



Alex Chow Date 6/28/2008



Suwen Yang Date 6/27/2008

Mark R. Greenstreet Date

Date

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WHEREAS, the undersigned,

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Alex Chow

Suwen Yang

Mark R. Greenstreet

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2. Said Inventor(s) hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventor(s) shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation reissues and

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reexaminations, opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventor(s) in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor(s), their respective heirs, legal representatives and assigns.

4. Said Inventor(s) hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, said Inventor(s) have executed and delivered this instrument to said Assignee as of the dates written below.

Robert J. Drost

Date

Alex Chow

Date

Suwen Yang

Date

Mark R. Greenstreet

15 October 2008

Mark R. Greenstreet

Date

Date